

CORRIGENDUM-2

Ref. No. IIT(BHU)/ECE/2026-27/176

Dated: 09.09.2026

Consequent upon the Pre-Bid meeting held on 31.08.2026 in reference to **Tender Ref. No.: IIT(BHU)/ECE/2026-27/176** for **Establishment of Advanced Semiconductor Processing Cleanroom Facility on Turnkey Basis including Design, Engineering, Supply, Installation, Integration and Commissioning in the Department of Electronics Engineering, IIT(BHU), Varanasi**, the following amendments are incorporated in aforesaid Tender Document. The Referred content in Col. No. 2 and 3 may be read as appended in Col. No. 4:

Sl. No. (1)	Page no. (2)	Content mentioned in Tender document (3)	Referred content should be read as (4)
1	Point no.10.3, Page no. 17	The Supplier shall make delivery of the 90 percent of the material should be delivered within 7 months of time with a project completion time of 10 months in pursuance of the notification of award. The purchase order would be placed after assessing the requirements on quarterly basis. However, the supplier shall also arrange to execute all orders on priority basis which would be placed to meet any emergent requirements.	The bidder shall make delivery of the 90 percent of the material within 5 months of time with a project completion time of 8 months from the date of issue of purchase order including mobilization period as well as the time required for obtaining all necessary approvals. However, the bidder shall also arrange to execute the project prior to the cut-off timeline to meet any emergent requirements.
2	Point no. 8.1, page no. 95	ESD or Antistatic Vinyl Flooring Design Requirements ESD or Antistatic vinyl flooring shall be provided in all ISO-5, ISO-6 and ISO-8 cleanroom areas as indicated in the approved cleanroom layout and drawings.	Antistatic Vinyl Flooring Design Requirements Antistatic vinyl flooring shall be provided in all ISO-5, ISO-6 and ISO-8 cleanroom areas as indicated in the approved cleanroom layout and drawings.
3	Page 1-7	Last Date of Bid Submission: 16.09.2026, 04:00 PM	Last Date of Bid Submission: 26.09.2026, 04:00 PM

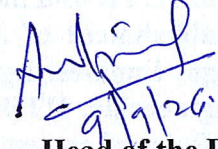
NOTE:

1. The quoted make/model should not have been discontinued from manufacturing as on the date of submission of bid. The bidder is required to submit the proof of the same. Also the details of

quoted make/model must be available on the website of their OEM.

2. The technical requirement mentioned in tender be considered as “**minimum technical requirement**”. Bidder can quote their product with higher specifications but not lower than the minimum technical requirement mentioned in the tender document.
3. The bidder must ensure before uploading their bid that they have filled all the required information in the formats mentioned in the tender document.
4. The bidder should also ensure **pagination** in each page of their bid document.

The remaining content of the Tender will remain unchanged.



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